54F/74F273 Octal D Flip-Flop

General Description

The 'F273 has eight edge-triggered D-type flip-flops with individual D inputs and Q outputs. The common buffered Clock (CP) and Master Reset (\overline{MR}) inputs load and reset (clear) all flip-flops simultaneously.

The register is fully edge-triggered. The state of each D input, one setup time before the LOW-to-HIGH clock transition, is transferred to the corresponding flip-flop's Q output.

All outputs will be forced LOW independently of Clock or Data inputs by a LOW voltage level on the \overline{MR} input. The device is useful for applications where the true output only is required and the Clock and Master Reset are common to all storage elements.

Features

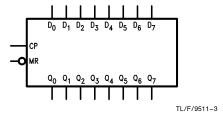
- Ideal buffer for MOS microprocessor or memory
- Eight edge-triggered D flip-flops
- Buffered common clock
- Buffered, asynchronous Master Reset
- See 'F377 for clock enable version
- See 'F373 for transparent latch version
- See 'F374 for TRI-STATE® version
- Guaranteed 4000V minimum ESD protection

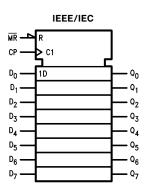
Commercial	Military	Package Number	Package Description		
74F273PC		N20A	20-Lead (0.300" Wide) Molded Dual-In-Line		
	54F273DM (Note 2)	J20A	20-Lead Ceramic Dual-In-Line		
74F273SC (Note 1)		M20B	20-Lead (0.300" Wide) Molded Small Outline, JEDEC		
74F273SJ (Note 1)		M20D	20-Lead (0.300" Wide) Molded Small Outline, EIAJ		
	54F273FM (Note 2)	W20A	20-Lead Cerpack		
	54F273LM (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C		

Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

Logic Symbols



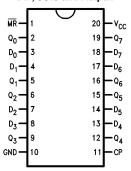


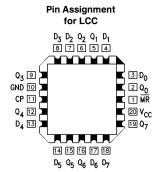
TL/F/9511-5

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Connection Diagrams

Pin Assignment for DIP, SOIC and Flatpak





TL/F/9511-2

TL/F/9511-1

Unit Loading/Fan Out

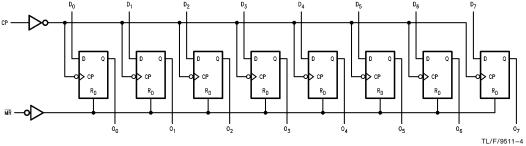
		54F/74F			
Pin Names	Description	U.L. HIGH/LOW	Input I _{IH} /I _{IL} Output I _{OH} /I _{OL}		
D ₀ -D ₇	Data Inputs	1.0/1.0	20 μA/-0.6 mA		
MR	Master Reset (Active LOW)	1.0/1.0	20 μA/ – 0.6 mA		
CP	Clock Pulse Input (Active Rising Edge)	1.0/1.0	20 μA/-0.6 mA		
Q_0-Q_7	Data Outputs	50/33.3	-1 mA/20 mA		

Mode Select-Function Table

Operating Mode		Output		
operating mode	MR	СР	Dn	Qn
Reset (Clear)	L	Х	Х	L
Load '1'	Н		h	Н
Load '0'	Н		ı	L

- $\begin{array}{ll} H = HIGH\ Voltage\ Level\ steady\ state \\ h = HIGH\ Voltage\ Level\ one\ setup\ time\ prior\ to\ the\ LOW-to-HIGH\ clock \end{array}$ transition
- L = LOW Voltage Level steady state I = LOW Voltage Level one setup time prior to the LOW-to-HIGH clock
- X = Immaterial $\mathcal{L} = IOW$ -to-HIGH clock transition

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 $\begin{array}{lll} \text{Storage Temperature} & -65^{\circ}\text{C to} + 150^{\circ}\text{C} \\ \text{Ambient Temperature under Bias} & -55^{\circ}\text{C to} + 125^{\circ}\text{C} \\ \text{Junction Temperature under Bias} & -55^{\circ}\text{C to} + 175^{\circ}\text{C} \\ \text{Plastic} & -55^{\circ}\text{C to} + 150^{\circ}\text{C} \\ \end{array}$

V_{CC} Pin Potential to

Voltage Applied to Output in HIGH State (with $V_{CC} = 0V$)

 $\begin{array}{lll} \text{Standard Output} & -0.5 \text{V to V}_{\text{CC}} \\ \text{TRI-STATE Output} & -0.5 \text{V to } +5.5 \text{V} \end{array}$

Current Applied to Output in LOW State (Max)

twice the rated I_{OL} (mA)

ESD Last Passing Voltage (min) 4000V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

Free Air Ambient Temperature

Supply Voltage

Military + 4.5V to + 5.5V Commercial + 4.5V to + 5.5V

DC Electrical Characteristics

Symbol	Parameter		54F/74F			Units	Vcc	Conditions	
Syllibol			Min	Тур	Max	Units	VCC	Conditions	
V_{IH}	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal	
V_{IL}	Input LOW Voltage				0.8	V		Recognized as a LOW Signal	
V_{CD}	Input Clamp Diode Voltage				-1.2	V	Min	$I_{\text{IN}} = -18 \text{ mA}$	
V _{OH}	Output HIGH Voltage	Mil 10% V _{CC} 5% V _{CC}	2.5 2.5 2.7			٧	Min	$I_{OH} = -1 \text{ mA}$	
V _{OL}	Output LOW Voltage	Mil 10% V _{CC} 5% V _{CC}			0.5 0.5 0.5	٧	Min	I _{OL} = 20 mA	
I _{IH}	Input HIGH Current	54F 74F			20.0 5.0	μΑ	Max	$V_{IN} = 2.7V$	
I _{BVI}	Input HIGH Current Breakdown Test	54F 74F			100 7.0	μΑ	Max	$V_{IN} = 7.0V$	
I _{CEX}	Output HIGH Leakage Current	54F 74F			250 50	μΑ	Max	$V_{OUT} = V_{CC}$	
V_{ID}	Input Leakage Test	74F	4.75			V	0.0	$I_{ m ID}=1.9~\mu{ m A}$ All other pins grounded	
I _{OD}	Output Leakage Circuit Current	74F			3.75	μΑ	0.0	V _{IOD} = 150 mV All other pins grounded	
I _{IL}	Input LOW Current				-0.6	mA	Max	V _{IN} = 0.5V	
los	Output Short-Circuit C	Current	-60		-150	mA	Max	$V_{OUT} = 0V$	
ICCH ICCL	Power Supply Current	t			44 56	mA	Max	CP =	

AC Electrical Characteristics

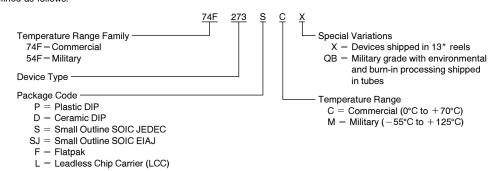
					54F T _A , V _{CC} = Mil C _L = 50 pF		74F T _A , V _{CC} = Com C _L = 50 pF		Units
Symbol	Parameter								
		Min	Тур	Max	Min	Max	Min	Max	
f _{max}	Maximum Clock Frequency	160			95		130		MHz
t _{PLH}	Propagation Delay Clock to Output	3.0 4.0		7.0 9.00	2.5 3.0	9.5 11.0	2.5 3.5	7.5 9.0	ns
t _{PLH}	Propagation Delay MR to Output	4.5		9.5	3.0	11.0	4.0	10.0	ns

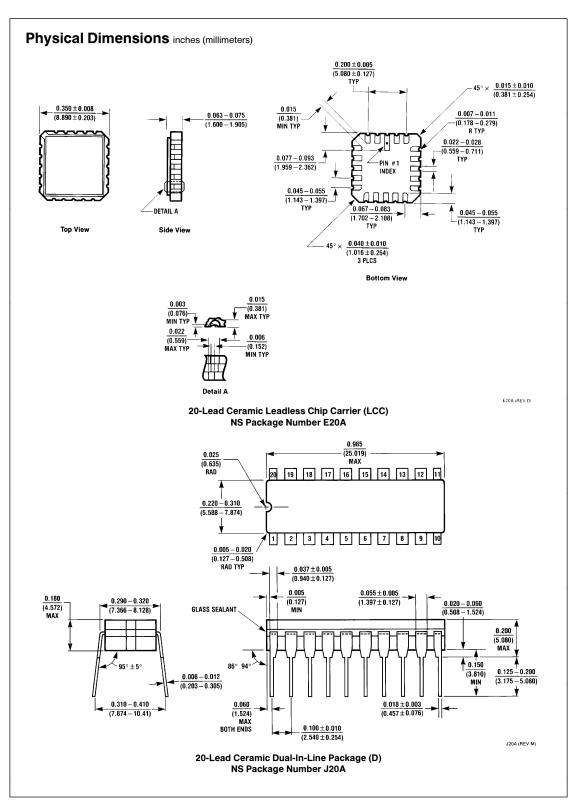
AC Operating Requirements

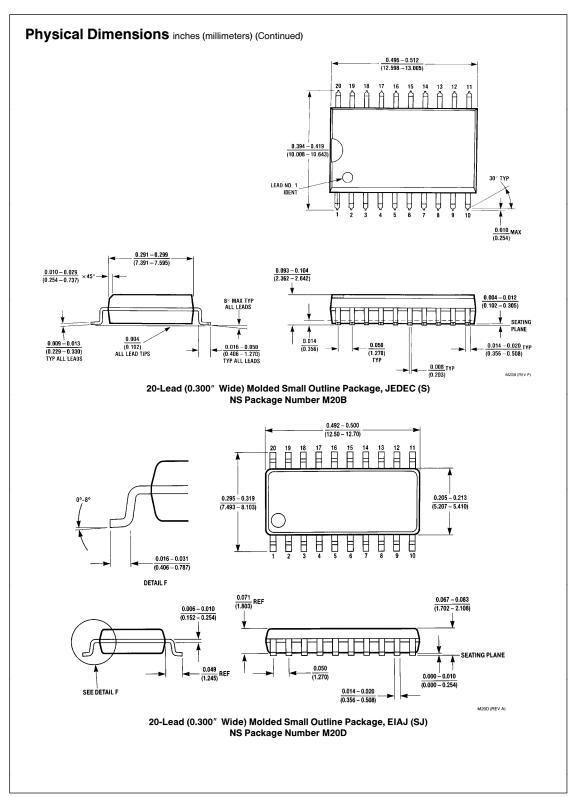
		$74F$ $T_A = +25^{\circ}C$ $V_{CC} = +5.0V$		54	F	74F T _A , V _{CC} = Com		Units
Symbol	Parameter			T _A , V _{CO}	; = Mil			
		Min	Max	Min	Max	Min	Max	
t _S (H) t _S (L)	Setup Time, HIGH or LOW Data to CP	3.0 3.5		3.5 4.0		3.0 3.5		- ns
t _h (H) t _h (L)	Hold Time, HIGH or LOW Data to CP	0.5 1.0		1.0 1.0		0.5 1.0		113
t _w (L)	MR Pulse Width, LOW	6.0		4.0		6.0		ns
t _w (H)	CP Pulse Width HIGH or LOW	6.0 6.0		5.0 5.0		6.0 6.0		ns
t _{rec}	Recovery Time, MR to CP	3.0		4.5		3.5		ns

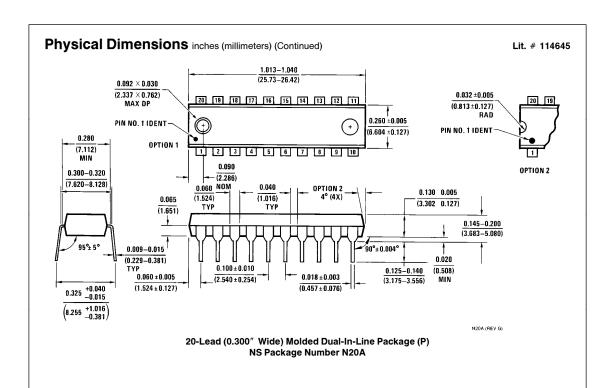
Ordering Information

The device number is used to form part of a simplified purchasing code where a package type and temperature range are defined as follows:

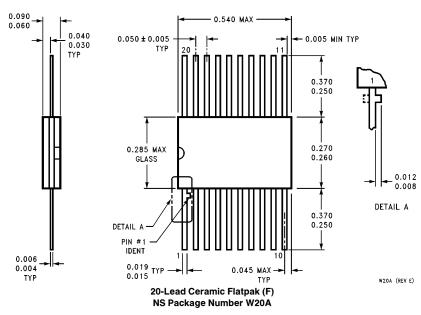








Physical Dimensions inches (millimeters) (Continued)



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